Pb Free Product

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE2301B uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications.

General Features

• $V_{DS} = -20V, I_{D} = -2.6A$

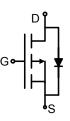
 $R_{DS(ON)}$ < 160m Ω @ V_{GS} =-2.5V

 $R_{DS(ON)} < 120 m\Omega$ @ V_{GS} =-4.5V

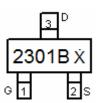
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM applications
- Load switch



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|------------|
| 2301B X | NCE2301B | SOT-23 | Ø180mm | 8 mm | 3000 units |

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|---------------------|------------|--|
| Drain-Source Voltage | V _{DS} | -20 | V |
| Gate-Source Voltage | V _{GS} | ±12 | V |
| Drain Current-Continuous | I _D | -2.6 | Α |
| Drain Current -Pulsed (Note 1) | I _{DM} | -13 | Α |
| Maximum Power Dissipation | P _D | 0.9 | W |
| Operating Junction and Storage Temperature Range | T_{J} , T_{STG} | -55 To 150 | $^{\circ}\!$ |

Thermal Characteristic

| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 138 | °C/W |
|--|-----------------|-----|-------|
| | 1 100/1 | 100 | 07.00 |

Electrical Characteristics (T_A=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|---------------------------------|-------------------|--|-----|-----|-----|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =-250μA | -20 | | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-20V,V _{GS} =0V | - | - | -1 | μA |



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| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|------|----------|------|------|
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±12V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | • | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$, $I_{D}=-250\mu A$ | -0.4 | -0.7 | -1 | V |
| Drain Course On Ctata Desistance | R _{DS(ON)} | V _{GS} =-4.5V, I _D =-2 A | - | 78 | 120 | mΩ |
| Drain-Source On-State Resistance | | V _{GS} =-2.5V, I _D =-1.8A | - | 102 | 160 | mΩ |
| Forward Transconductance | g FS | V _{DS} =-5V,I _D =-1A | 6 | - | - | S |
| Dynamic Characteristics (Note4) | , | | | <u>I</u> | | |
| Input Capacitance | C _{lss} | V _{DS} =-10V,V _{GS} =0V, | - | 325 | - | PF |
| Output Capacitance | Coss | | - | 63 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0MHz | - | 37 | - | PF |
| Switching Characteristics (Note 4) | | | • | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 11 | - | nS |
| Turn-on Rise Time | t _r | V_{DD} =-10V, R_L =5 Ω | - | 5.5 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =-4.5 V , R_{GEN} =3 Ω | - | 22 | - | nS |
| Turn-Off Fall Time | t _f | | - | 8 | - | nS |
| Total Gate Charge | Qg | \/ 40\/ L 0A | - | 3.2 | - | nC |
| Gate-Source Charge | Q _{gs} | V_{DS} =-10V, I_{D} =-2A, | - | 0.6 | - | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} =-4.5V | - | 0.9 | - | nC |
| Drain-Source Diode Characteristics | | | • | I . | • | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =2A | - | - | -1.2 | V |
| Diode Forward Current (Note 2) | I _S | | - | - | -2.6 | Α |

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

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Typical Electrical and Thermal Characteristics

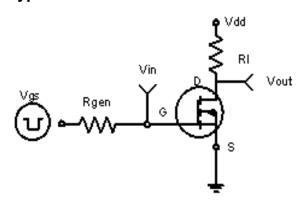


Figure 1:Switching Test Circuit

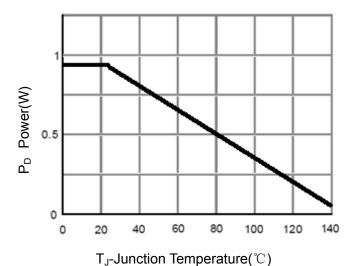


Figure 3 Power Dissipation

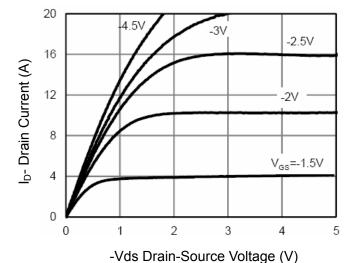


Figure 5 Output Characteristics

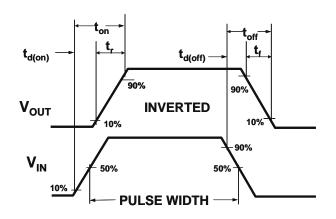


Figure 2:Switching Waveforms

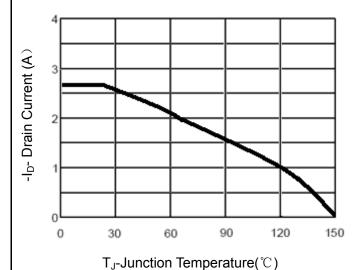


Figure 4 Drain Current

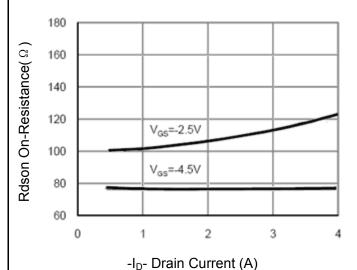


Figure 6 Drain-Source On-Resistance



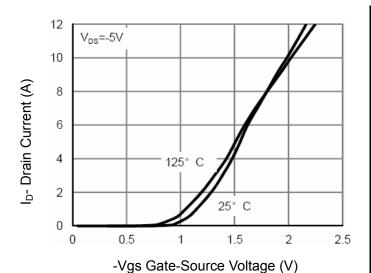
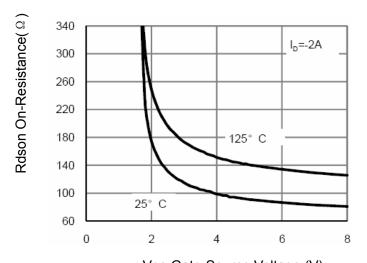


Figure 7 Transfer Characteristics



-Vgs Gate-Source Voltage (V)Figure 9 Rdson vs Vgs

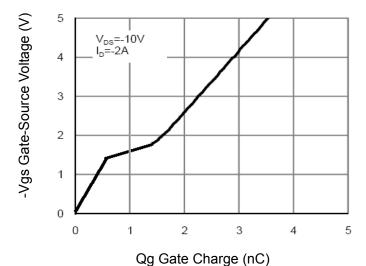


Figure 11 Gate Charge

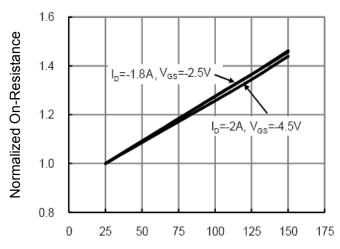


Figure 8 Drain-Source On-Resistance

 T_J -Junction Temperature($^{\circ}$ C)

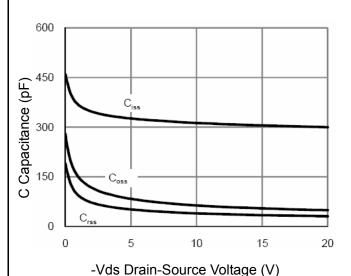


Figure 10 Capacitance vs Vds

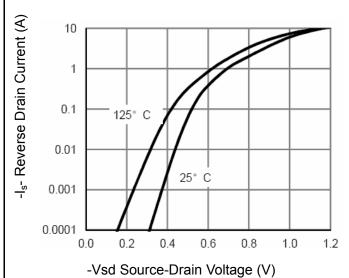


Figure 12 Source- Drain Diode Forward

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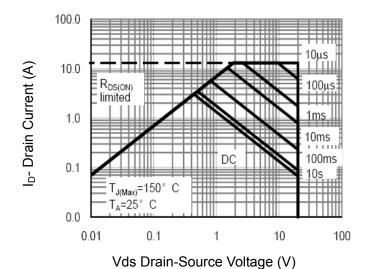


Figure 13 Safe Operation Area

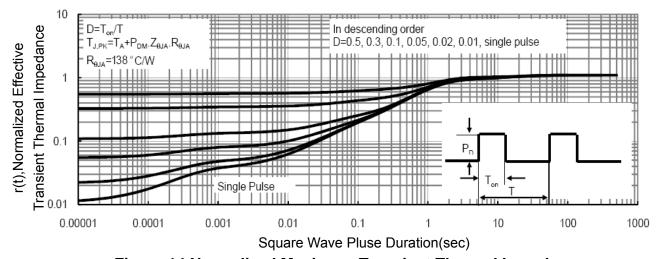
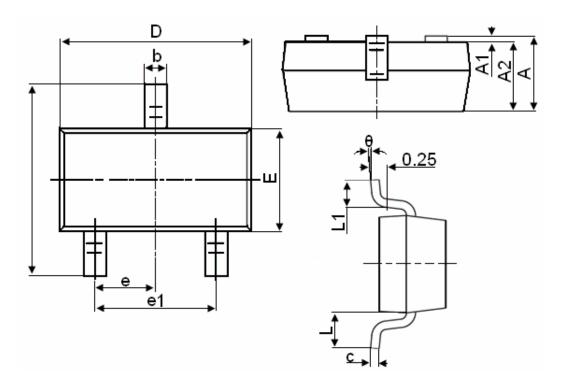


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



| Cumbal | Dimensions in Millimeters | | | | |
|--------|---------------------------|----------|--|--|--|
| Symbol | MIN. | MAX. | | | |
| А | 0.900 | 1.150 | | | |
| A1 | 0.000 | 0.100 | | | |
| A2 | 0.900 | 1.050 | | | |
| b | 0.300 | 0.500 | | | |
| С | 0.080 | 0.150 | | | |
| D | 2.800 | 3.000 | | | |
| E | 1.200 | 1.400 | | | |
| E1 | 2.250 | 2.550 | | | |
| е | | 0.950TYP | | | |
| e1 | 1.800 | 2.000 | | | |
| L | | 0.550REF | | | |
| L1 | 0.300 | 0.500 | | | |
| θ | 0° | 8° | | | |

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$



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